'ER SHEET

U.S. Department of Commerce Patent and Trademark Office

٦	To the Honorable Commissioner 1013321/8	ached original documents or copy thereof
Γ	Name of conveying party(ies):	Name and address of receiving party(ies):
	Allen McTeer	Name: Micron Technology, Inc.
	Additional name(s) of conveying Yes party(ies) attached?	Internal Address: Street Address: 8000 S. Federal Way
	3. Nature of Conveyance: X Assignment Mefger	City: Boise
	Security Agreement Change of Name	State: <u>Idaho</u> Zip: <u>83706-9632</u>
	Other	Country: USA
	Execution Date(s): 3/29/00	Additional name(s) & Yes address(es) attached? X No
	4. Application number(s) or patent number(s):	
	If this document is being filed together with a new appli- the Execution date(s) of the new application is (are):	cation, March 29, 2000
	A. Patent Application No.(s):	B. Patent No.(s):
		Additional numbers attached? Yes X No
	Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
	Name: DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP	7. Total fee (37 C.F.R 3.41) \$ \$40.00
	Internal Address: Atty. Dkt.: M4065.0247/P247	x Enclosed
	Attn: Thomas J. D'Amico	Authorized to be charged to deposit account
SCARMICH	Street Address: 2101 L Street NW	Credit any overpayment or debit any underpayment
	City: State: Zip: DC 20037 - 1526	8. Deposit account number: 4 - 1073
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	9. Statement and signature.	
	To the best of my knowledge and belief, the forecopy is a true copy of the original document.	going information is true and correct and any attached
	Thomas J. D'Amico	April 11, 2000
	Signature	Date
	Reg. No. 28,371	achments, and document: 3
	Total number of pages including cover sheet, atta	echniems, and document. 3

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> PATENT REEL: 010712 FRAME: 0946

Docket No.: M4065.0247/P247 Micron No.: 98-1148

ASSIGNMENT AND AGREEMENT

For value received, I, Allen McTeer hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled USE OF AlN AS COPPER PASSIVATION LAYER AND THERMAL CONDUCTOR, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

1108661 v1; NRG5011.DOC

Docket No.: M4065.0247/P247 Micron No.: 98-1148

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Date:

United States of America

State of <u>Odaho</u>
County of <u>Qda</u>

On this 29 day of March, 2000, before me ___ , to me known to be the personally came Allen McTeer individual described in and who executed the foregoing instrument, and acknowledged

execution of the same.

1108661 v1; NRG501! DOC

RECORDED: 04/11/2000

PATENT REEL: 010712 FRAME: 0948